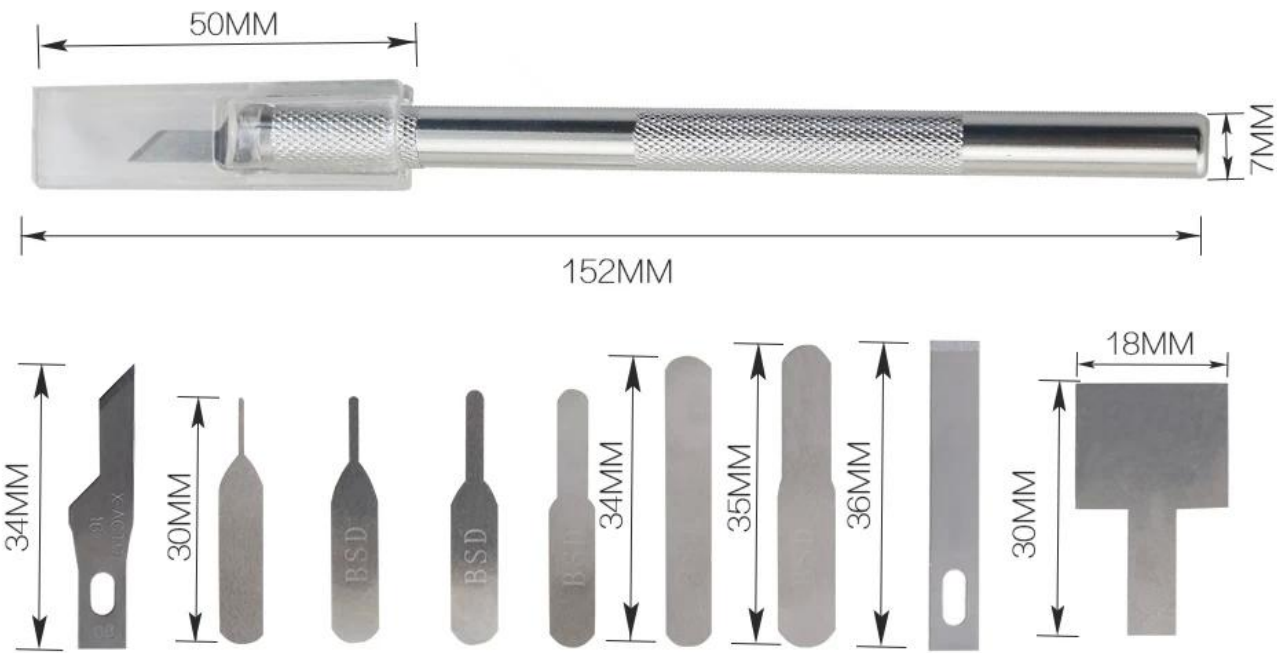
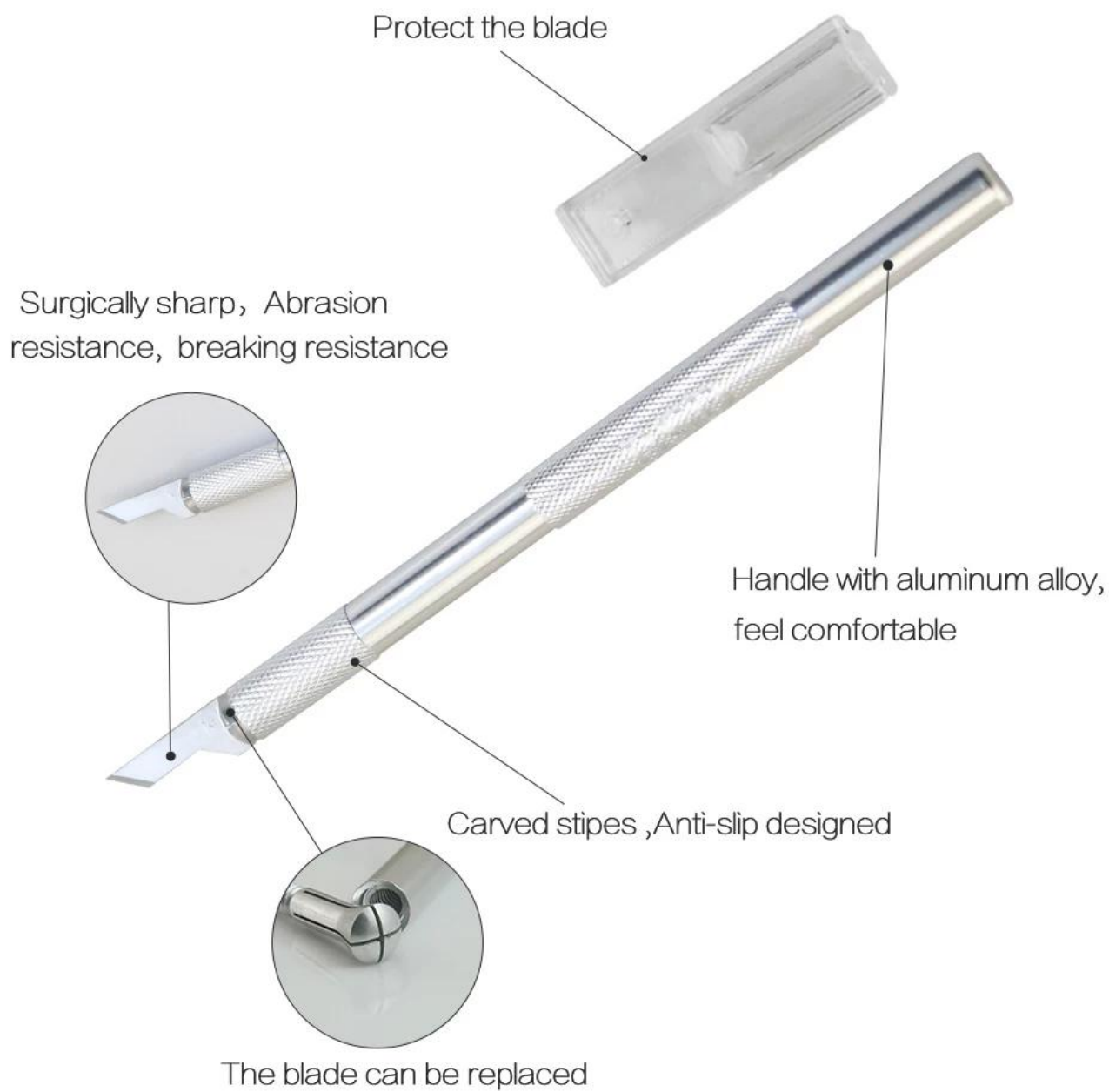


PRODUCT SIZE



PRODUCT FEATURES



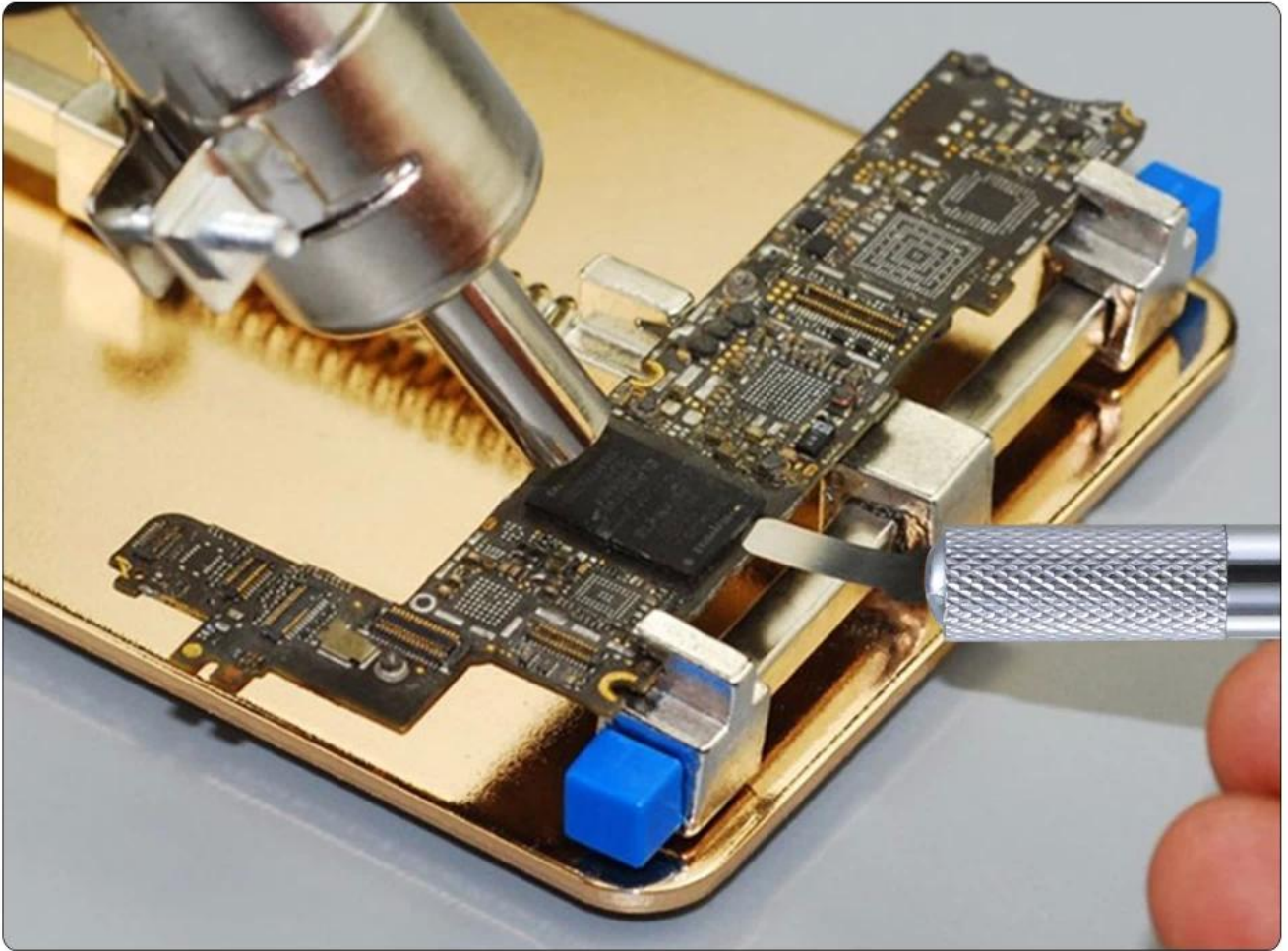


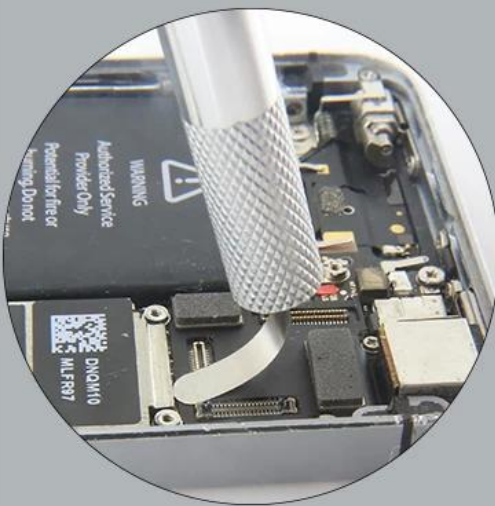
- ① Carving knife
- ② Carving knife
- ③ Remove a variety of small vinyl chip can not afford to drop.
- ④ Remove the 6S power IC variety of glass IC, do not hurt the glass, no risk.
- ⑤ With baseband CPU wifi module.
- ⑥ Dismantling the upper CPU deflated.
- ⑦ Remove the A4-A9 CPU without risk.
- ⑧ Demolition A8 A9CPU dedicated point.
- ⑨ Scraper knife demolition of a variety of chips, scraping the CPU once again, without repeating back and forth scraping.

Use this tool to repair the BGA chip, such as baseband, CPU, etc. can play a half-skill, times the effect. Easy to operate, can not afford to point, can not afford copper, easy to clean and so on, safe and risk-free.

The air gun temperature should be between 340-360 - between 28-30 winds.

PRODUCT PHOTOGRAPH





Ultra-thin silicon-manganese alloy steel, wear resistance, toughness, heat, low temperature, anti-oxidation, corrosion resistance.



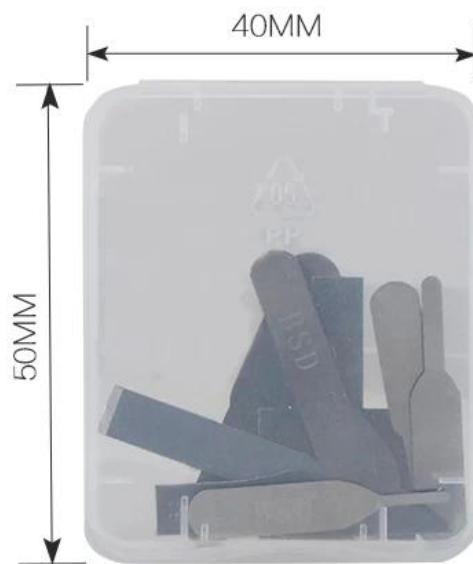


PRODUCT PACKAGING

WEIGHT:41G



PACKAGING



PACKAGING